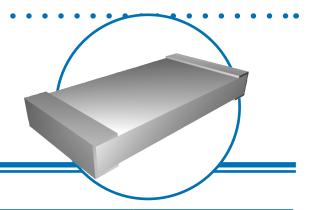
High Voltage Chip Resistors



HVC Series

- · Continuous voltages up to 3KV
- Resistance Values from $100 \text{K}\Omega$ to $100 \text{M}\Omega$
- Tolerances of ±0.5% to ±10%
- Sn/Pb or Matte Sn wrap-around terminations
- Standard chip sizes available from 1206 to 2512
- · Robust thick film construction



Electrical Data

Characteristic	1206	2010	2512		
Maximum Rated Voltage ¹	1000V	2000V	3000V		
Voltage Coefficient of Posistance	-25 ppm/V Max.	-15 ppm/V Max.	-5 ppm/V Max.		
Voltage Coefficient of Resistance	-15 ppm/V Typ.	-5 ppm/V Typ.	-1.5 ppm/V Typ.		
Resistance Range (Tolerance)	100KΩ to 10M (±0.5%²,±1%, ±2% ,±5%, ±10%)				
nesistance nange (Tolerance)	10MΩ to 100MΩ (±5%, ±10%)				
Power @ 70°C	300mW 500mW		1000mW		
Operating Temperature	-55°C to +155°C				
Thermal Impedance	200°C/W	80°C/W	70°C/W		
TCR	±100ppm/°C				
Termination	Wrap-around Sn/Pb or matte Sn with leach resistant Ni barrier				

Notes: 1. Voltage Limited to \sqrt{PxR} 2. $\pm 0.5\%$ in 2512 package only

Environmental Data

Test	Maximum ∆R	Typical ∆R	
Load life at rated power (1000 hours @ 70°C)	0.50%	0.25%	
Overload (6.25 X rated power for 2 seconds)	0.50%	0.10%	
High temperature storage (1000 hours @ 155°C)	0.50%	0.20%	
Moisture resistance	0.50%	0.25%	
Thermal shock	0.25%	0.05%	
Resistance to soldering heat	0.25%	0.05%	



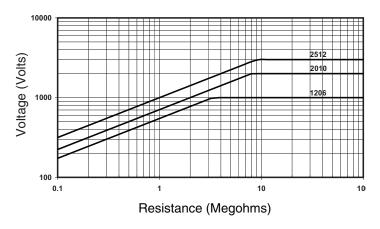
High Voltage Chip Resistors



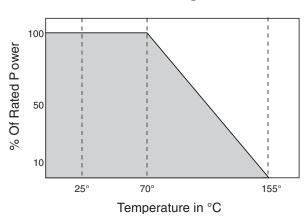
Physical Data

	L (mm)	W (mm)	T max (mm)	A (mm)	C (mm)	Weight (grams)	L
1206	3.2±0.2	1.6±0.2	0.6	0.5±0.2	0.5±0.2	0.010	c
2010	5.3±0.2	2.5±0.2	0.7	0.5±0.2	0.5±0.2	0.035	
2512	6.6±0.2	3.2±0.2	0.7	0.5±0.2	0.5±0.2	0.055	

Maximum Continuous Voltage



Power Derating Data



Construction: Thick film resistor material, overglaze and organic protection are screen printed on a 96% alumina substrate. Wrap-around terminations have an electroplated nickel barrier and tin-lead solder or matte-tin finish, ensuring excellent 'leach' resistance properties and solderability. Wrap around terminations ensure reliable contact. This robust construction enables the resistor to be mounted on one side of a printed circuit board and a wire-leaded component applied on the opposite side.

Marking: Components are not marked. Reels are marked with type, value, tolerance, date code and quantity.

Solvent resistance: The body protection is resistance to all normal industrial cleaning solvents suitable for printed circuits.

PCB Layout Recommendation: Avoid running conducting traces between the HVC mounting pads, as this would compromise the rated voltage.

Ordering Data

Prefix · · · · · TKC - HVC	2512LF -	3M30	- F
	•		
Chip Type		•	
	:		
Size and Termination 1206 = Sn/Pb solder termination 1206LF = 100% Tin (pb-free) termination 2010 = Sn/Pb solder termination 2010LF = 100% Tin (pb-free) termination 2512LF = 100% Tin (pb-free) termination 2512LF = 100% Tin (pb-free) termination			
Resistance Value · · · · · · · · · · · · · · · · · · ·	• • • • • • •	:	
4 digit code: 100K=100,000 ohms, 1M20=1,200,000 ohms			
Tolerance Code	• • • • • •	• • • • •	• • •

For additional information or to discuss your specific requirements, please contact our Applications Team using the contact details below.